

TOSHIBA GTR MODULE SILICON N CHANNEL IGBT

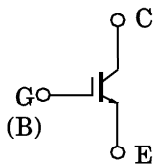
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HIGH POWER SWITCHING APPLICATIONS

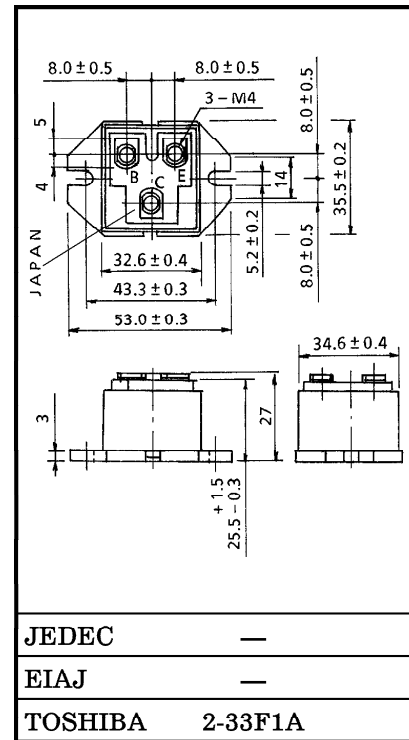
MOTOR CONTROL APPLICATIONS

- High Input Impedance
- High Speed : $t_f = 1.0 \mu s$ (Max.) ($I_C = 150A$)
- Low Saturation Voltage : $V_{CE(sat)} = 2.7V$ (Max.) ($I_C = 150A$)
- Enhancement-Mode
- The Electrodes are Isolated from Case.

EQUIVALENT CIRCUIT



Unit in mm



Weight : 86g

MAXIMUM RATINGS ($T_a = 25^\circ C$)

CHARACTERISTIC	SYMBOL	RATING	UNIT
Collector-Emitter Voltage	V_{CES}	600	V
Gate-Emitter Voltage	V_{GES}	± 20	V
Collector Current	DC	I_C	150
	1ms	I_{CP}	300
Collector Power Dissipation	P_C	450	W
Junction Temperature	T_j	150	$^\circ C$
Storage Temperature Range	T_{stg}	$-40 \sim 125$	$^\circ C$
Isolation Voltage	V_{Isol}	2500 (AC 1 minute)	V
Screw Torque (Terminal / Mounting)	—	2 / 3	N·m

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ELECTRICAL CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC		SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Gate Leakage Current		I_{GES}	$V_{GE} = \pm 20V, V_{CE} = 0$	—	—	± 500	nA
Collector Cut-Off Current		I_{CES}	$V_{CE} = 600V, V_{GE} = 0$	—	—	1.0	mA
Gate-Emitter Cut-Off Voltage		$V_{GE (off)}$	$V_{CE} = 5V, I_C = 150mA$	3.0	—	6.0	V
Collector-Emitter Saturation Voltage		$V_{CE (sat)}$	$I_C = 150A, V_{GE} = 15V$	—	2.3	2.7	V
Input Capacitance		C_{ies}	$V_{CE} = 10V, V_{GE} = 0, f = 1MHz$	—	12000	—	pF
Switching Time	Rise Time	t_r		—	0.3	0.8	μs
	Turn-On Time	t_{on}		—	0.4	1.0	
	Fall Time	t_f		—	0.6	1.0	
	Turn-Off Time	t_{off}		—	1.0	1.6	
Thermal Resistance		$R_{th(j-c)}$		—	—	0.278	°C/W

